



# HGTP3N60B3D, HGT1S3N60B3D, HGT1S3N60B3DS

## ADVANCE INFORMATION

September 1997

## 7A, 600V, UFS Series N-Channel IGBT with Anti-Parallel Hyperfast Diode

### Features

- 7A, 600V,  $T_C = 25^\circ\text{C}$
- 600V Switching SOA Capability
- Typical Fall Time ..... 115ns at  $T_J = 150^\circ\text{C}$
- Short Circuit Rating
- Low Conduction Loss
- Hyperfast Anti-Parallel Diode

### Ordering Information

PART NUMBER	PACKAGE	BRAND
HGTP3N60B3D	TO-220AB	G3N60B3D
HGT1S3N60B3D	TO-262AA	G3N60B3D
HGT1S3N60B3DS	TO-263AB	G3N60B3D

NOTE: When ordering, use the entire part number. Add the suffix 9A to obtain the TO-263AB variant in tape and reel, i.e., HGT1S3N60B3DS9A

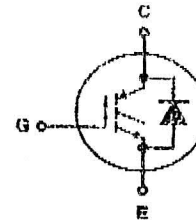
### Description

The HGTP3N60B3D, HGT1S3N60B3D, and HGT1S3N60B3DS are MOS gated high voltage switching devices combining the best features of MOSFETs and bipolar transistors. These devices have the high input impedance of a MOSFET and the low on-state conduction loss of a bipolar transistor. The much lower on-state voltage drop varies only moderately between  $25^\circ\text{C}$  and  $150^\circ\text{C}$ . The diode used in anti-parallel with the IGBT is the RHRD460.

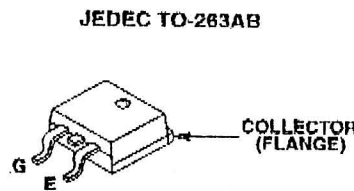
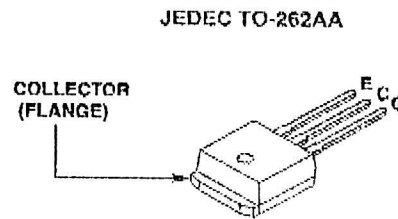
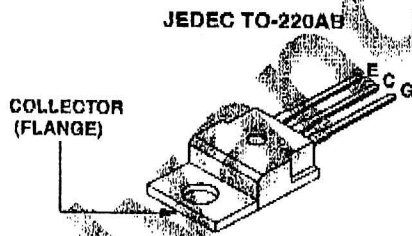
The IGBT is ideal for many high voltage switching applications operating at moderate frequencies where low conduction losses are essential, such as: AC and DC motor controls, power supplies and drivers for solenoids, relays and contactors.

Formerly Developmental Type TA49193.

### Symbol



### Packaging



### HARRIS SEMICONDUCTOR IGBT PRODUCT IS COVERED BY ONE OR MORE OF THE FOLLOWING U.S. PATENTS

4,364,073	4,417,385	4,430,792	4,443,931	4,466,176	4,516,143	4,532,534	4,567,641
4,587,713	4,598,461	4,605,948	4,618,872	4,620,211	4,631,564	4,639,754	4,639,762
4,641,162	4,644,637	4,682,195	4,684,413	4,694,313	4,717,679	4,743,952	4,783,690
4,794,432	4,801,966	4,803,533	4,809,045	4,809,047	4,810,665	4,823,176	4,837,606
4,860,080	4,883,767	4,888,627	4,890,143	4,901,127	4,904,609	4,933,740	4,963,951
4,969,027							

CAUTION: These devices are sensitive to electrostatic discharge. Users should follow proper ESD Handling Procedures.  
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File Number 4414

# HGTP3N60B3D, HGT1S3N60B3D, HGT1S3N60B3DS

## Electrical Specifications $T_C = 25^\circ\text{C}$ , Unless Otherwise Specified (Continued)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Current Turn-On Delay Time	$t_{(ON)}$	IGBT and Diode at $T_J = 25^\circ\text{C}$ $I_{CE} = I_{C110}$ $V_{CE} = 0.8 V_{CES}$ $V_{GE} = 15\text{V}$ $R_G = 82\Omega$ $L = 1\text{mH}$ Test Circuit - (Figure 19)	-	18	-	ns
Current Rise Time	$t_r$		-	16	-	ns
Current Turn-Off Delay Time	$t_{(OFF)}$		-	105	-	ns
Current Fall Time	$t_f$		-	70	-	ns
Turn-On Energy	$E_{ON}$		-	66	75	$\mu\text{J}$
Turn-Off Energy (Note 1)	$E_{OFF}$		-	88	160	$\mu\text{J}$
Current Turn-On Delay Time	$t_{(ON)}$	IGBT and Diode at $T_J = 150^\circ\text{C}$ $I_{CE} = I_{C110}$ $V_{CE} = 0.8 V_{CES}$ $V_{GE} = 15\text{V}$ $R_G = 82\Omega$ $L = 1\text{mH}$ Test Circuit - (Figure 19)	-	16	-	ns
Current Rise Time	$t_r$		-	18	-	ns
Current Turn-Off Delay Time	$t_{(OFF)}$		-	220	285	ns
Current Fall Time	$t_f$		-	115	175	ns
Turn-On Energy	$E_{ON}$		-	130	140	$\mu\text{J}$
Turn-Off Energy (Note 1)	$E_{OFF}$		-	210	325	$\mu\text{J}$
Diode Forward Voltage	$V_{EC}$	$I_{EC} = 3\text{A}$	-	2.0	2.5	V
Diode Reverse Recovery Time	$t_{RR}$	$I_{EC} = 1\text{A}, di_{EC}/dt = 200\text{A}/\mu\text{s}$	-	-	22	ns
		$I_{EC} = 3\text{A}, di_{EC}/dt = 200\text{A}/\mu\text{s}$	-	-	28	ns
Thermal Resistance Junction To Case	$R_{\theta JC}$	IGBT	-	-	3.75	$^\circ\text{C}/\text{W}$
		Diode	-	-	3.0	$^\circ\text{C}/\text{W}$

**NOTE:**

1. Turn-Off Energy Loss ( $E_{OFF}$ ) is defined as the integral of the instantaneous power loss starting at the trailing edge of the input pulse and ending at the point where the collector current equals zero ( $I_C = 0\text{A}$ ). All devices were tested per JEDEC Standard No. 24-1 Method for Measurement of Power Device Turn-Off Switching Loss. This test method produces the true total Turn-Off Energy Loss. Turn-On losses include losses due to diode recovery.

## Typical Performance Curves (Unless Otherwise Specified)

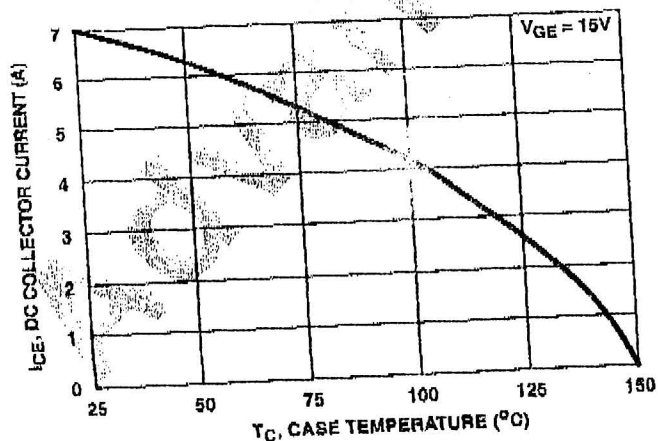


FIGURE 1. DC COLLECTOR CURRENT AS A FUNCTION OF CASE TEMPERATURE

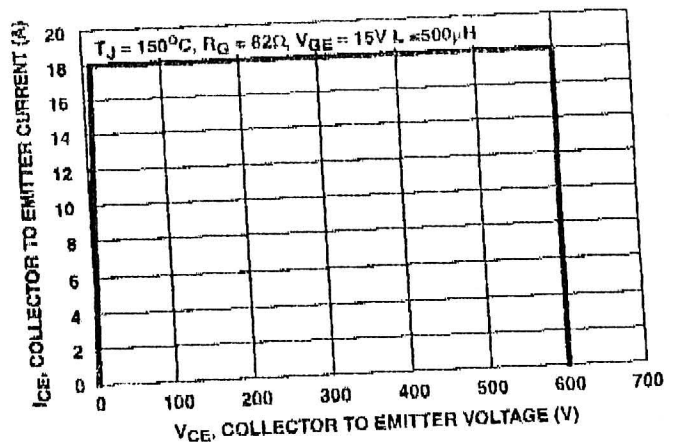


FIGURE 2. MINIMUM SWITCHING SAFE OPERATING AREA

# HGTP3N60B3D, HGT1S3N60B3D, HGT1S3N60B3DS

## Typical Performance Curves (Unless Otherwise Specified) (Continued)

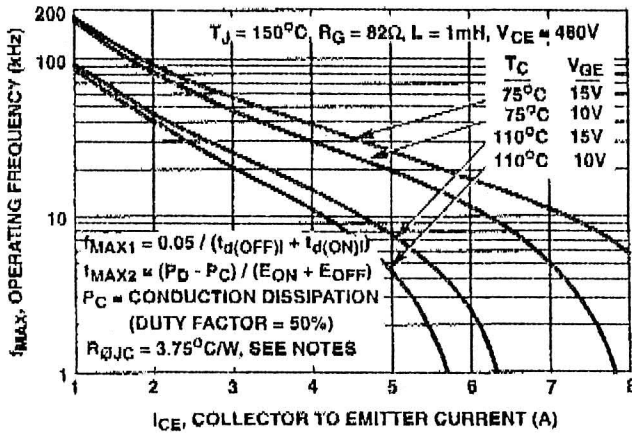


FIGURE 3. OPERATING FREQUENCY AS A FUNCTION OF COLLECTOR TO EMITTER CURRENT

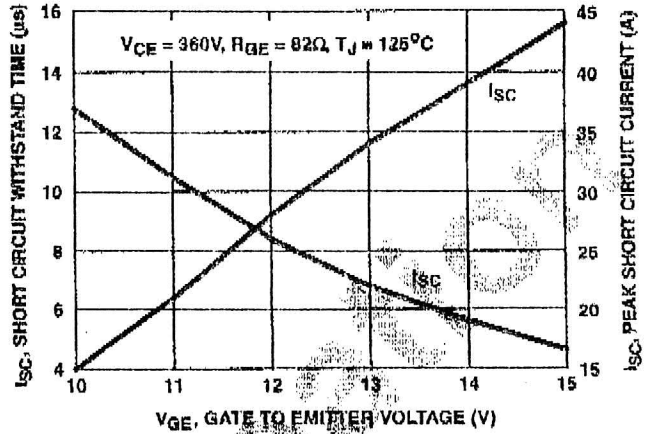


FIGURE 4. SHORT CIRCUIT WITHSTAND TIME

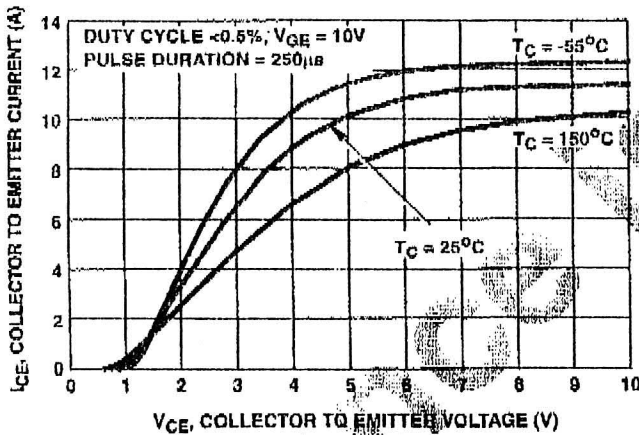


FIGURE 5. COLLECTOR TO EMITTER ON-STATE VOLTAGE

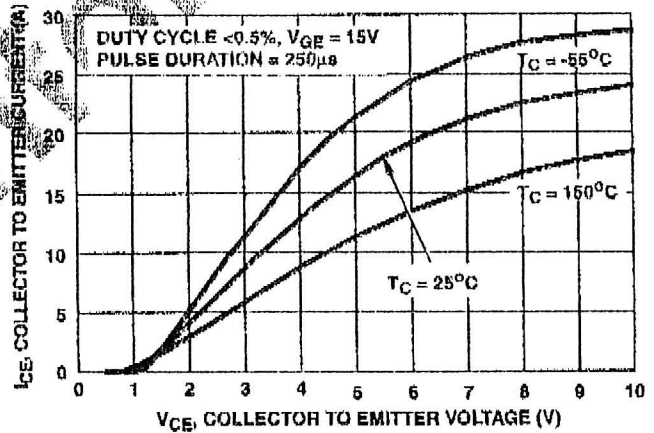


FIGURE 6. COLLECTOR TO EMITTER ON-STATE VOLTAGE

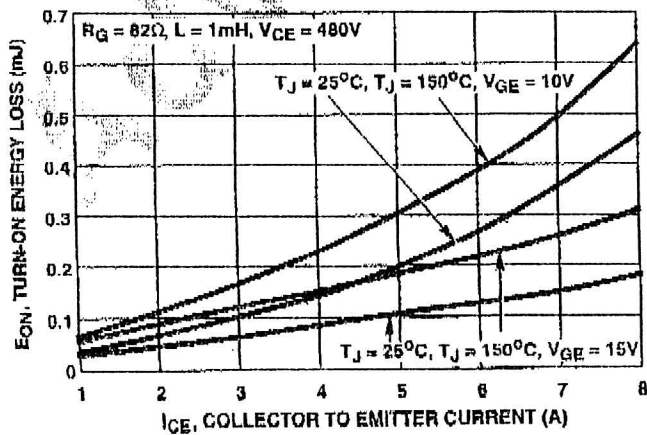


FIGURE 7. TURN-ON ENERGY LOSS AS A FUNCTION OF COLLECTOR TO EMITTER CURRENT

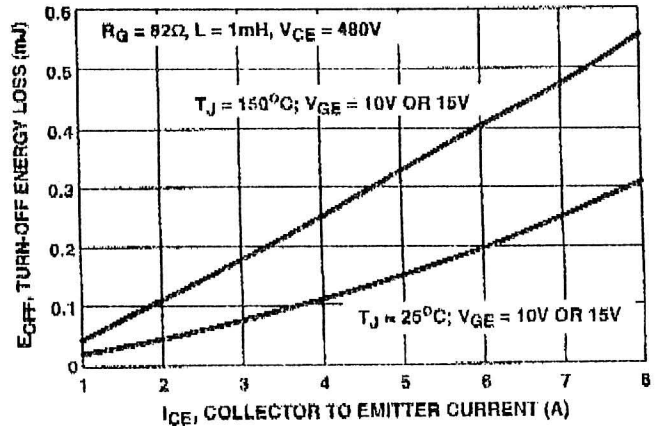


FIGURE 8. TURN-OFF ENERGY LOSS AS A FUNCTION OF COLLECTOR TO EMITTER CURRENT

HGTP3N60B3D, HGT1S3N60B3D, HGT1S3N60B3DS

Typical Performance Curves (Unless Otherwise Specified) (Continued)

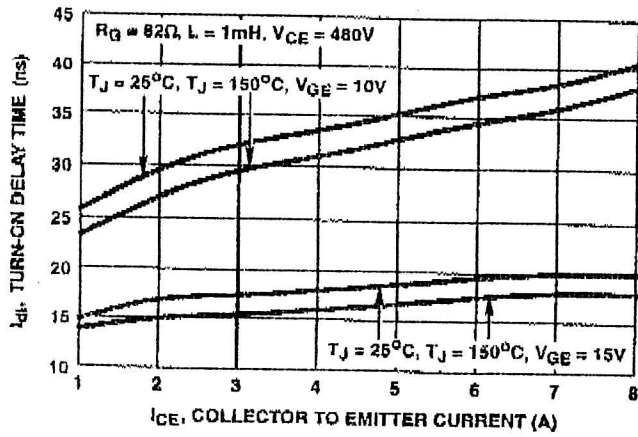


FIGURE 9. TURN-ON DELAY TIME AS A FUNCTION OF COLLECTOR TO EMITTER CURRENT

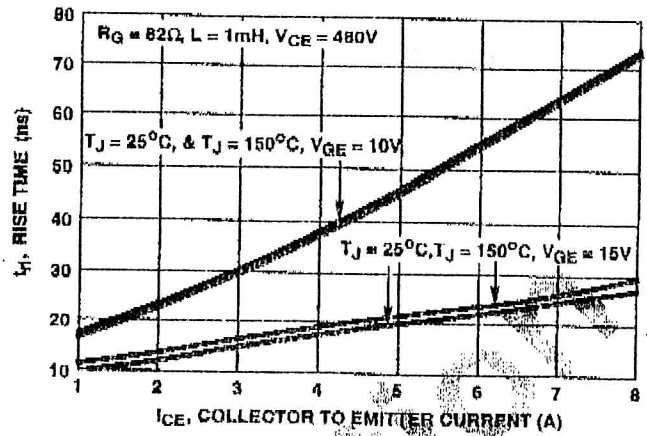


FIGURE 10. TURN-ON RISE TIME AS A FUNCTION OF COLLECTOR TO EMITTER CURRENT

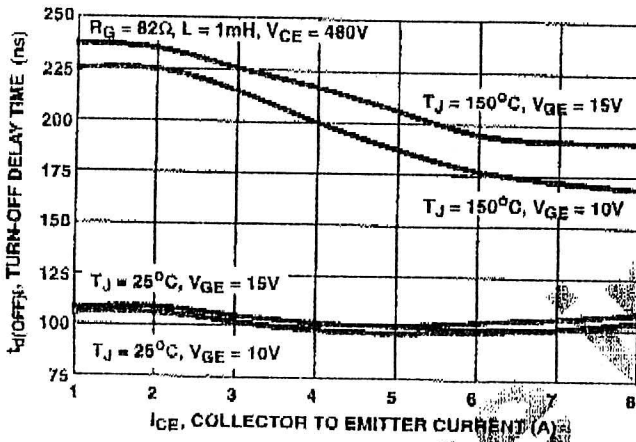


FIGURE 11. TURN-OFF DELAY TIME AS A FUNCTION OF COLLECTOR TO EMITTER CURRENT

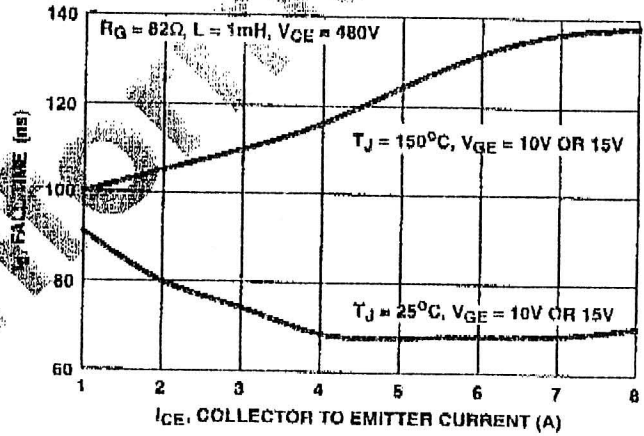


FIGURE 12. FALL TIME AS A FUNCTION OF COLLECTOR TO EMITTER CURRENT

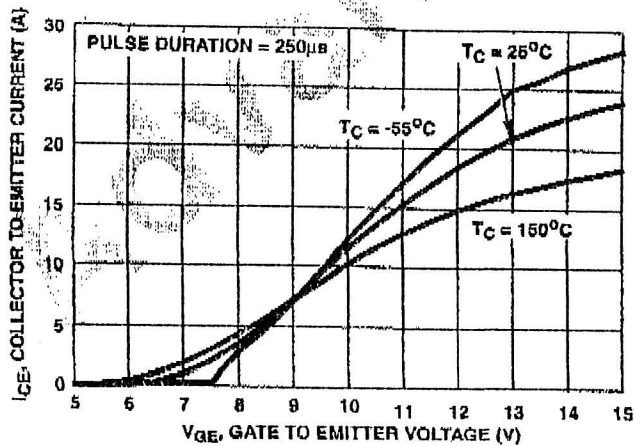


FIGURE 13. TRANSFER CHARACTERISTIC

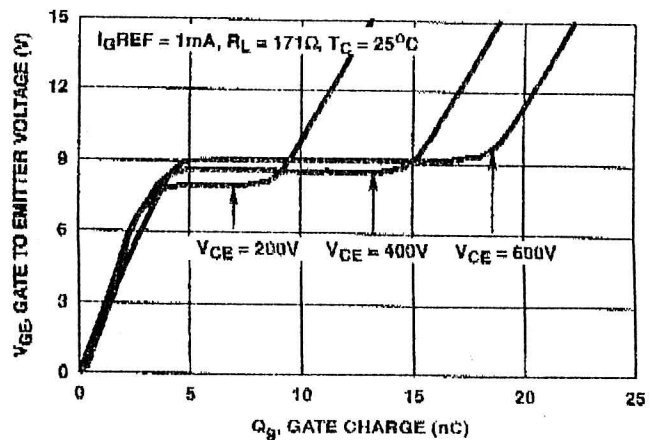


FIGURE 14. GATE CHARGE WAVEFORMS

HGTP3N60B3D, HGT1S3N60B3D, HGT1S3N60B3DS

Typical Performance Curves (Unless Otherwise Specified) (Continued)

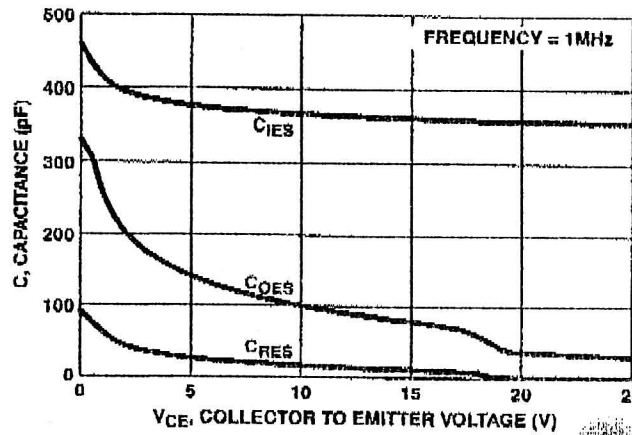


FIGURE 15. CAPACITANCE AS A FUNCTION OF COLLECTOR TO EMITTER VOLTAGE

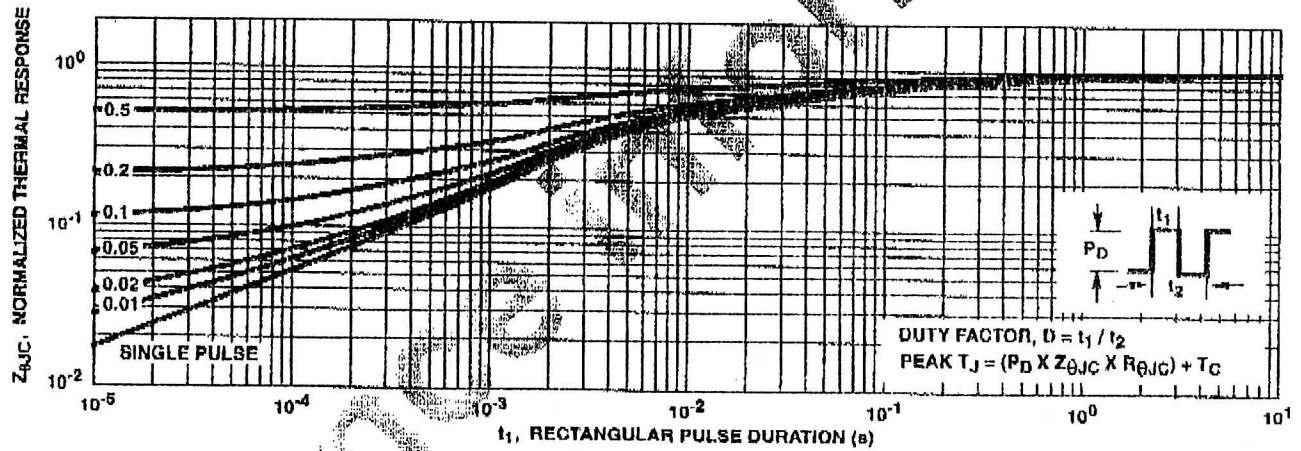


FIGURE 16. NORMALIZED TRANSIENT THERMAL RESPONSE, JUNCTION TO CASE

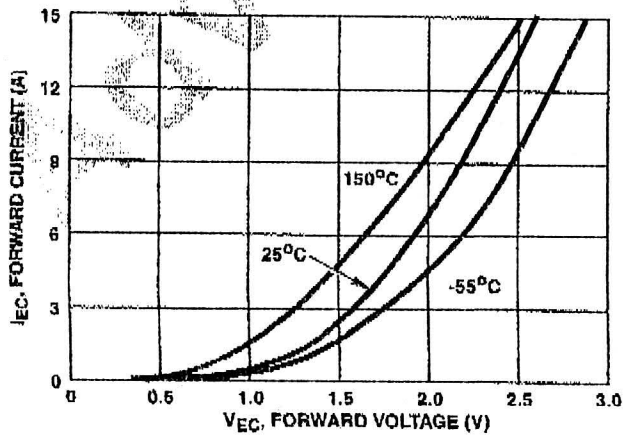


FIGURE 17. DIODE FORWARD CURRENT AS A FUNCTION OF FORWARD VOLTAGE DROP

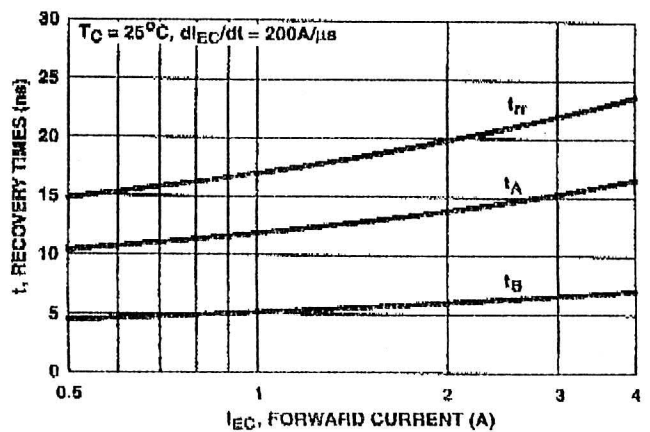


FIGURE 18. RECOVERY TIME AS A FUNCTION OF FORWARD CURRENT